Sheet 1 of 1				ATTY DOCEET NO. 352USF	SERIAL NO. 10/001,543 GROUP 1724 1724		1,3
WATE	sc	LOSURE STAT	EMENT	Sasssaman et al.	Ç,	App.	KCK,
				October 31, 2001	GROUF 1	724/0	2003
			U.S. PA	ATENT DOCUMENTS		ン	<u> </u>
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	OFILING DATE
J.C.	AA	US - 3,658,697	04/25/72	Huether	210	18	
l·c·	AB	US - 3,870,033	03/11/75	Faylor et al.	126	360	
L·c.	AC	US - 3,873,581	03/25/75	Fitzpatrick et al.	260	370	
$\lambda \cdot 0.$	AD	US - 3,928,192	12/23/75	Katzakian, Jr. et al.	210	30	
L· C.	AE	US - 4,303,704	12/01/81	Courduvelis et al.	427	345	
1.c.	AF	US - 5,045,213	09/03/91	Bowers	210	709	
f. C.	AG	US - 5,149,437	09/22/92	Wilkinson et al.	210	665	
χ·c.	АН	US - 5,348,588	09/20/94	Winston	134	10	
l.c.	Al	US - 5,348,724	09/20/94	Hagimori et al.	423	531	
7.0.	AJ	US - 5,558,775	09/24/96	Busch. Jr	210	638	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
L	<u> </u>	<u> </u>	<u> </u>				YES NO
l·c.	AK	0 761 603	12.03.1997	European	C02F	1/463	
J.C	AL	WO 97/29048	14.08.1997	World	C02F	1/28	
l·c.	АМ	06121978 Abstract	06.05.1994	Japan	C02F	1/28	
l·c.	AN	08024897 Abstract	30.01.1996	Japan	C02F	9/00	
1.0.	AO	08039054 Abstract	13.02.1996	Japan	C02F	1/28	
l.c.	AP	08141579 Abstract	04.06.1996	Japan	C02F	1/58	
l.c.	AQ	10111387 Abstract	28.04.1998	Japan	G21C	19/307	
L.c.	AR	09117763 Abstract	06.05.1997	Japan	C02F	1/44	
$l \cdot c$.	AS	55062794 Abstract	12.05.1980	Japan			

		OTH	ER DOCUMENTS
L·c.	AT	"A Circuit Board Manufacturer's So and Production, vol. 35, no. 9 01.08	lution to Wastewater Treatment" Electronic Packaging 8.1995 pg 85
Examiner	Date Co	Insidered Cintins	July 27, 2003

* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPLP 609, draw line through citation if not in conformance and not conside PTO-1449 (Modified)